

DEC

FLIP CHIP MODULES TEST SPECS

TYPE: R001

DIODE CLUSTER ⁰⁰¹

TEST	CONDITIONS	MINIMUM	MAXIMUM
DC TEST DIODE FORWARD VOLTAGE DROP	CONNECT 7.5K TO -15V ON ALL OUTPUTS	600 V	750 V

DEC 8 1964



TECHNICAL INFORMATION

Instruction literature and technical bulletins are available on all digital products, if you would like to be added to our mailing list for this type of material or if you have any questions about the equipment you have purchased, please contact the nearest Digital Sales Office.

MAINTENANCE INFORMATION

Repair of printed circuitry should be done with a low voltage, fairly cool soldering iron to prevent damage to the transistors and keep the copper from lifting.
Oscilloscopes used to troubleshoot a module or system should be grounded to prevent damaging transients.